

View Online at https://aerobasegroup.com/nsn/5910-01-344-5539

Body Style:
Chip type
Reliability Indicator:
Established
Reliability Failure Rate Level In Percent:
0.001
Terminal Length:
Between 0.005 inches and 0.025 inches
Body Length:
Between 0.090 inches and 0.145 inches
Body Width:
Between 0.090 inches and 0.130 inches
Body Height:
Between 0.030 inches and 0.102 inches
Schematic Diagram Designator:
No common or grounded electrode (s)
Insulation Resistance At Maximum Operating Temp:
1000.0 megohms
Capacitance Value Per Section:
0.500 picofarads single section
Nonderated Operating Temp:
Between -55.0 degrees celsius and 125.0 degrees celsius
Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:
0.0 single section
Nonderated Continuous Voltage Rating And Type Per Section:
500.0 dc single section
Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:
-30.0/+30.0 single section
Tolerance Range Per Section:
-0.10/+0.10 picofarads single section
Case Material:
Ceramic
Insulation Resistance At Reference Temp:
100000.0 megohms
Dissipation Factor At Reference Tempurature In Percent:
0.150
Terminal Surface Treatment:
Solder
Test Data Document:
81349-mil-c-55681 specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification
format; excludes commercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain
environmental and performance requirements and test conditions that are shown as "typical", "average", "", etc.).

## Terminal Type And Quantity:

2 bonding pad



**Specification Data:** 

81349-mil-c-55681/4 government specification

Shelf Life:

N/a

Unit Of Measure:

---

Demilitarization:

No

Fiig:

A010b0